Reactive Silicone Flexible Hardeners for Epoxy Resins

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Epoxy Resins

- Myriad Applications
 - Adhesives
 - Aerospace
 - Coatings
 - Composites
 - Construction
 - Electronics
 - Specialty Applications
 - Transportation



Epoxy Resins

- Thermoset
- Often 2k
- Diverse Base Resins
- Cure Mechanisms
 - Amine
 - Mercapto
 - Anhydride
 - UV Initiated Acid
- Modifiers





Epoxy Resin Properties

- Few Compromises
- Solvent Resistance
- Low Shrinkage
- Processability
- Insulative
- Adhesion
- Strength
- Relatively Brittle





Need for Flexible Epoxies

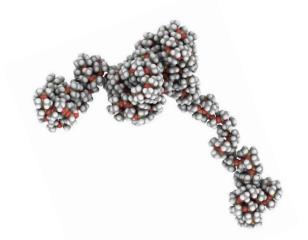
- Adhesives
- Composites
- Electronics
- Floors
- Marine
- Plastics
- Wood





Silicones

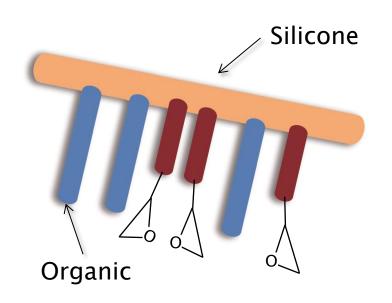
- Incompatible
- Gas Permeable
- ▶ Low Tg: -120°C
- Low Order of Toxicity
- Flexible, Compressible
- Low Surface Energy (ST, COF)
- Very Good Thermal Flexibility
- Excellent Spreading and Wetting
- Insulative (Electrical and Thermal)
- ▶ Thermally and Radical Stable (O₂, O₃, Sunlight)
- Good Chemical and Very Good Water Resistance





Reactive Silicones

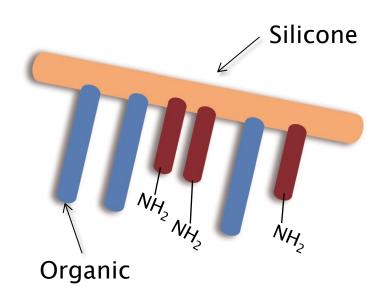
- Silicones can by synthesized with a variety of reactive groups including cycloaliphatic or glycidyl epoxy moieties.
- These can be reacted as homopolymers or copolymers with other epoxy resins





Reactive Silicones as Hardeners

- ...or amine functionality
- These reactive silicones can be used as "flexible hardeners."
- The organic groups provide solubility.



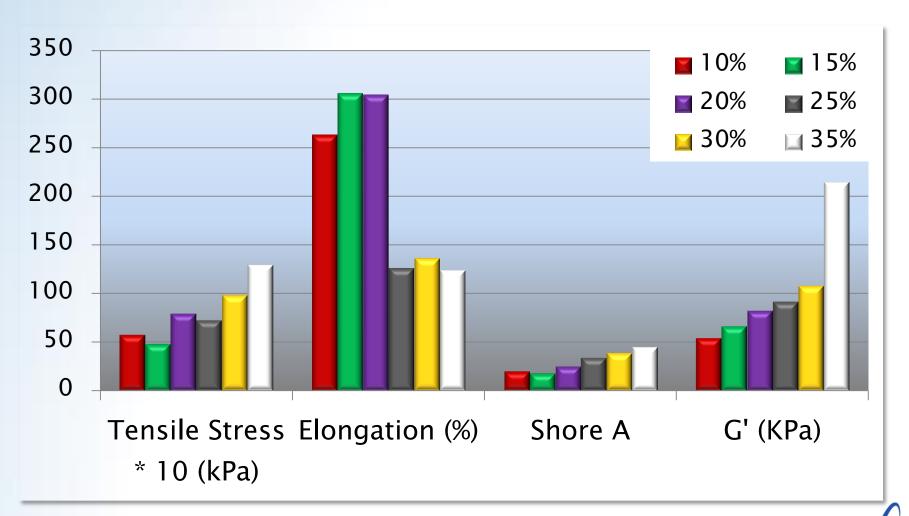


Concept Proof: Epoxy Silicone Resins

- Three cycloaliphatic epoxy silicones are reacted in various ratios.
- Blends of High / Low MW di-functional epoxy silicones and a high X-link epoxy silicone.
- Cross-linking epoxy silicone kept at 8%
- ▶ MHHPA and Imicure AM-1 used to affect cure.
- Cured at 100°C for 4 hours.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.



Cycloaliphatic Epoxy Silicones





Silicones Used

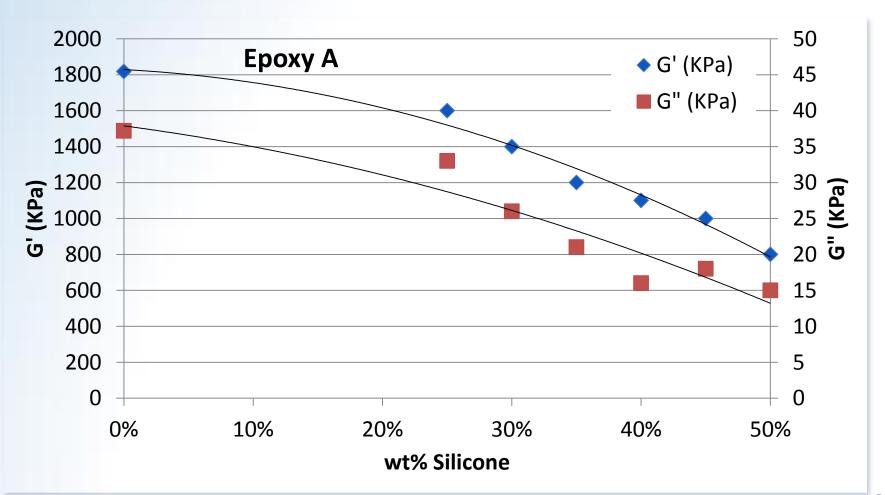
	# Reactive	Equivalent	Organic
Silicone	Sites	Weight	Group
Epoxy A	1 EP/3 OH	2400	Polyether
Epoxy B	1 EP/5 OH	8200	Polyether
Hydroxyl A	3 OH	3800	None
Hydroxyl B	2 OH	1980	None
Hydroxyl C	4 OH	360	None
Hydroxyl D	4 OH	3000	Polyether
Amine A	4 NH ₂	300	None
Amine B	1 NH ₂ /3 OH	2550	Polyether
Amine C	2 NH ₂	450	None

DER 671-X75 Epoxy with Epoxy A

- Dow DER 671-X75, a commercial low MW, Epichlorohydrin/ bisphenol A system is reacted with epoxy silicone A.
- ▶ MHHPA and Imicure AM-1used to affect cure.
- Cured at 100°C for 4 hours.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.

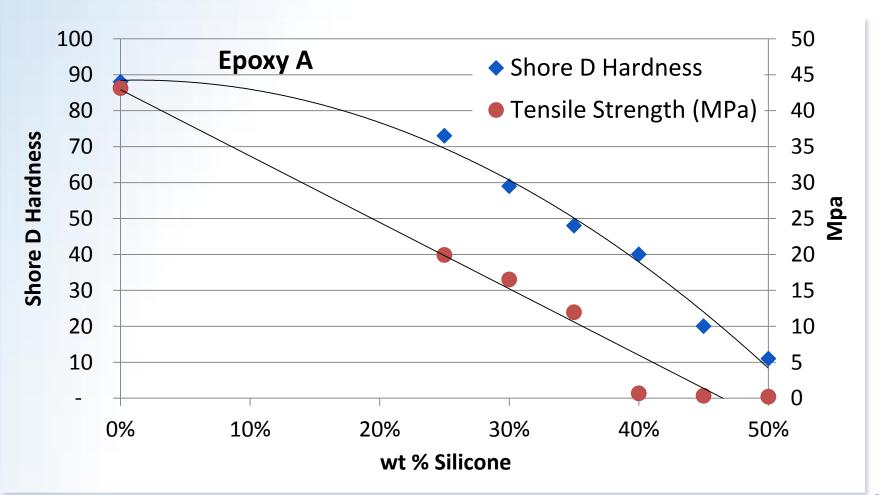


Moduli



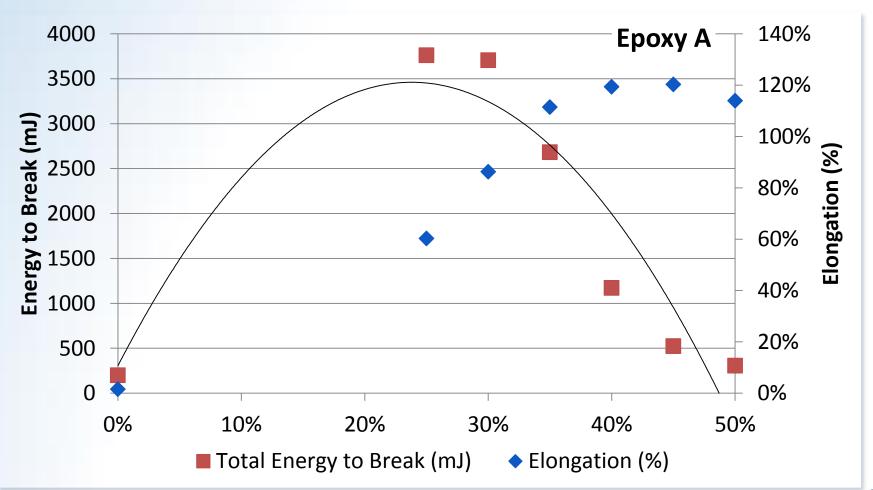


Hardness and Strength



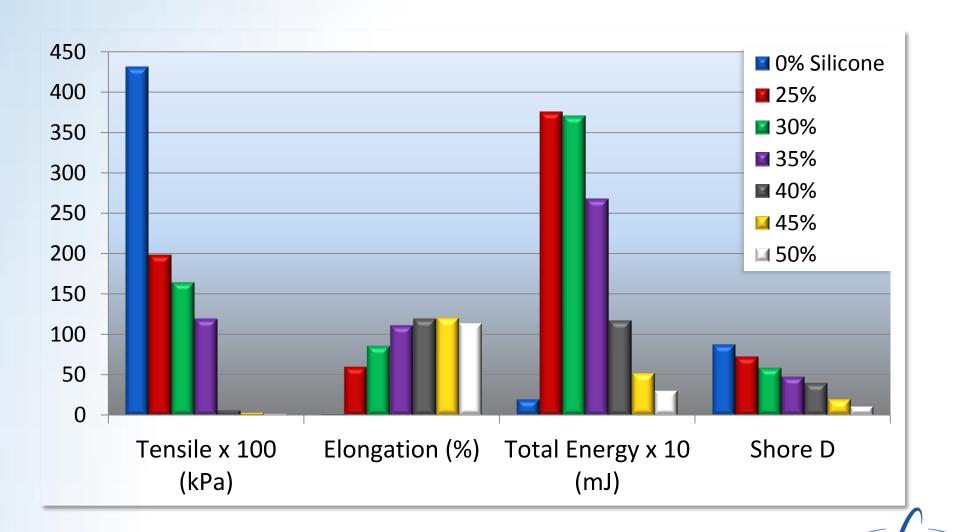


Total Energy to Break/ Elongation





Summary DER 671-X75 / Epoxy A

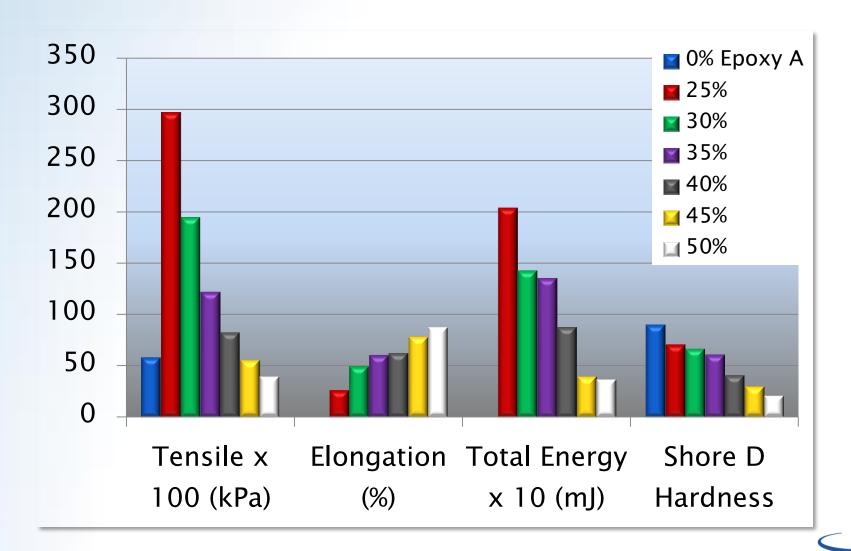


DER 331 with Epoxy A

- Dow DER 331, a commercial faster and softer, Epichlorohydrin/ bisphenol A system is reacted with epoxy silicone A.
- ▶ MHHPA and Imicure AM-1used to affect cure.
- Cured at 100°C for 4 hours.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.



DER 331 with Epoxy A

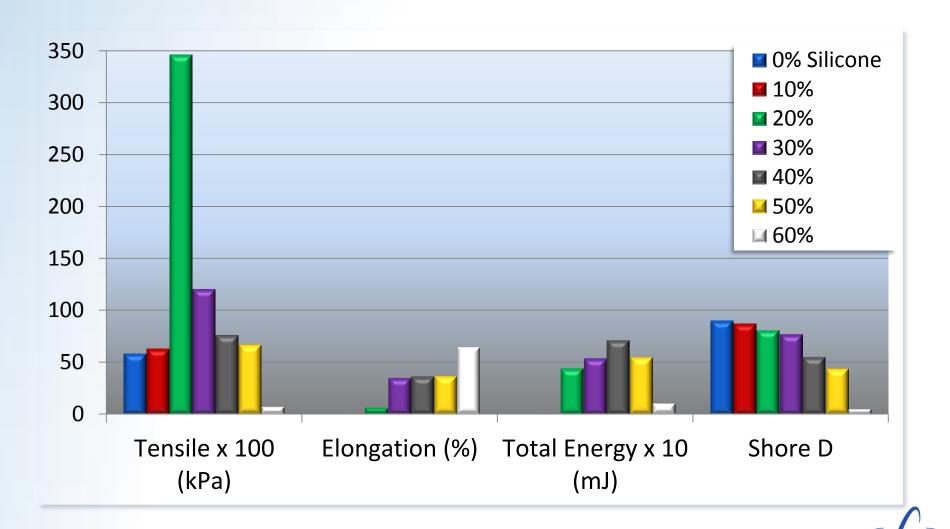


Cycloaliphatic with Epoxy B

- UVACure 1500, a commercial cycloaliphatic epoxy system is reacted with epoxy silicone B
- ▶ MHHPA and Imicure AM-1 used to affect cure.
- Cured at 100°C for 4 hours.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.



UVACure 1500 with Epoxy B

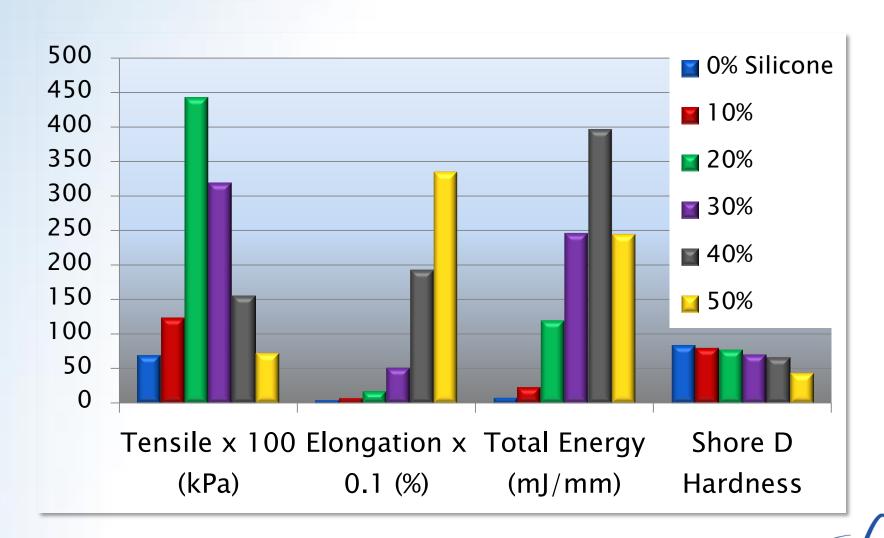


Cycloaliphatic / Epoxy B (UV)

- UVACure 1500, a commercial cycloaliphatic epoxy system is reacted with epoxy silicone B
- ▶ UV 9380 Photoinitiator used.
- Cured at RT under UV light.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.



UVACure 1500 / Epoxy B (UV)

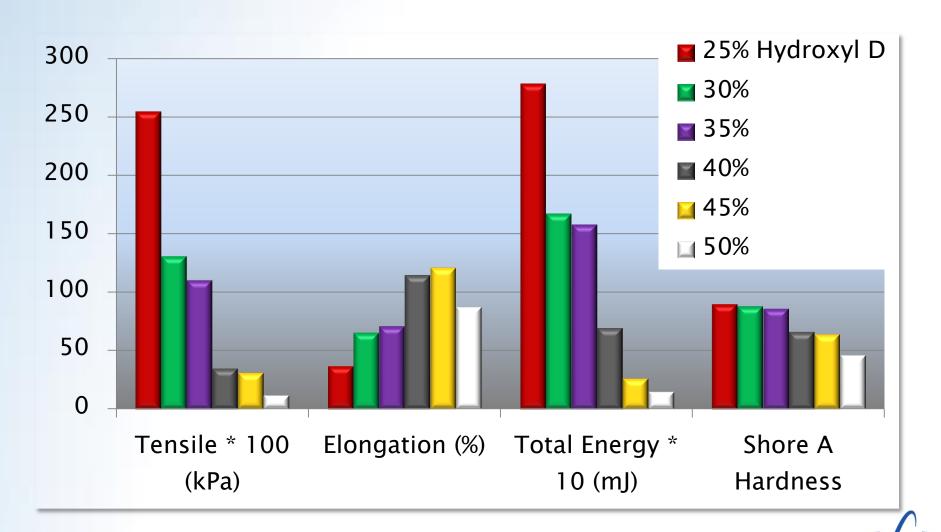


DER 331/ Hydroxyl Silicone D

- Dow DER 331, Epichlorohydrin/ bisphenol A system is reacted with Hydroxyl silicone D.
- ▶ MHHPA and Imicure AM-1 used to affect cure.
- Cured at 100°C for 4 hours.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122.



DER 331 with Hydroxyl D



Amine Hardened Epoxy/ Silicones

- Dow DER 331 Epichlorohydrin/ bisphenol A commercial system is reacted with reactive silicones
- ▶ MHHPA and Imicure AM-1used to affect cure.
- Cured at ambient for 24 hours.
- Ancamine 1618 is found to be best for hardening over Ancamine 1483 or TEPA.
- Properties are followed with Brookfield DV-III Rheometer AR-G2 or measured with Instron #1122



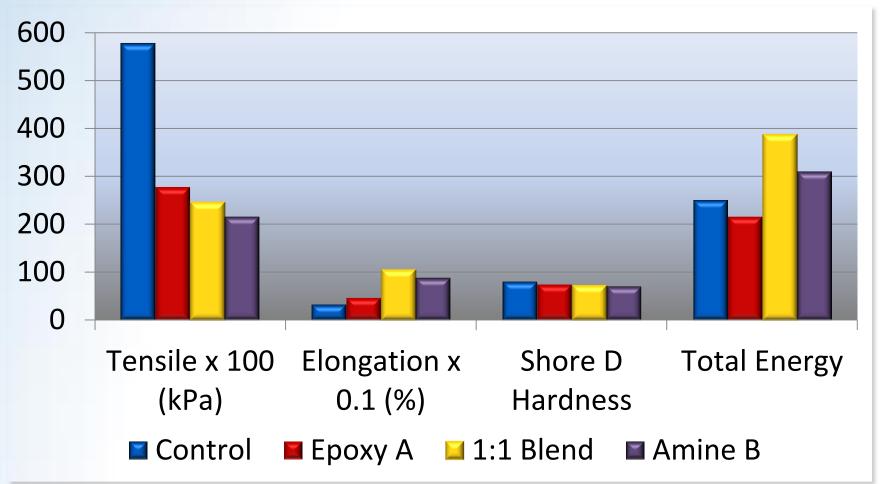
Silicone Hardeners

Replace 20% of Ancamine 1618 (hardener):

- Silicone Amine B
- Silicone Epoxy A
- ▶ 1:1 blend of Amine B/ Epoxy A



DER 331 with Hardener



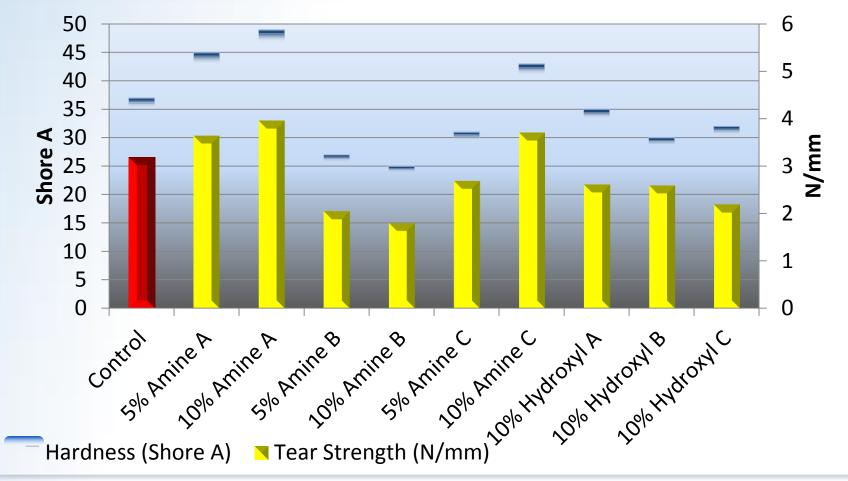


Rubber Filled Epoxy with Silicone Hardener

- Proprietary epoxy with 5-10% reactive silicones and rubber crumbs
- Mold and cure at ambient for 7 days
- ▶ -15°C and -30°C impact resistance
- Severity of fracture rated 1–10 (best)

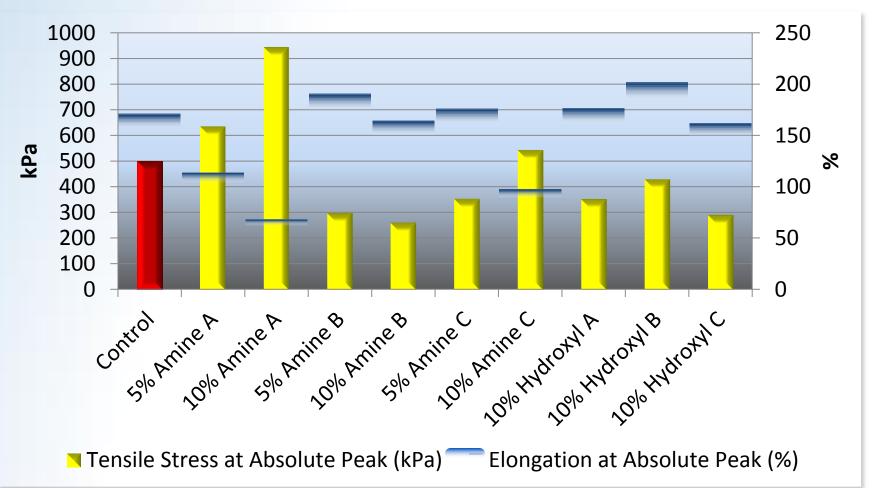


Hardness and Strength





Tensile Stress and Elongation

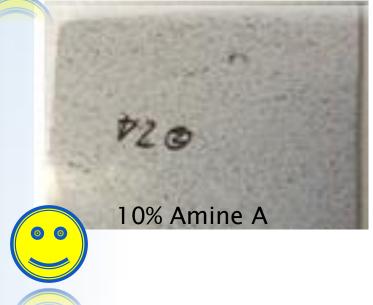






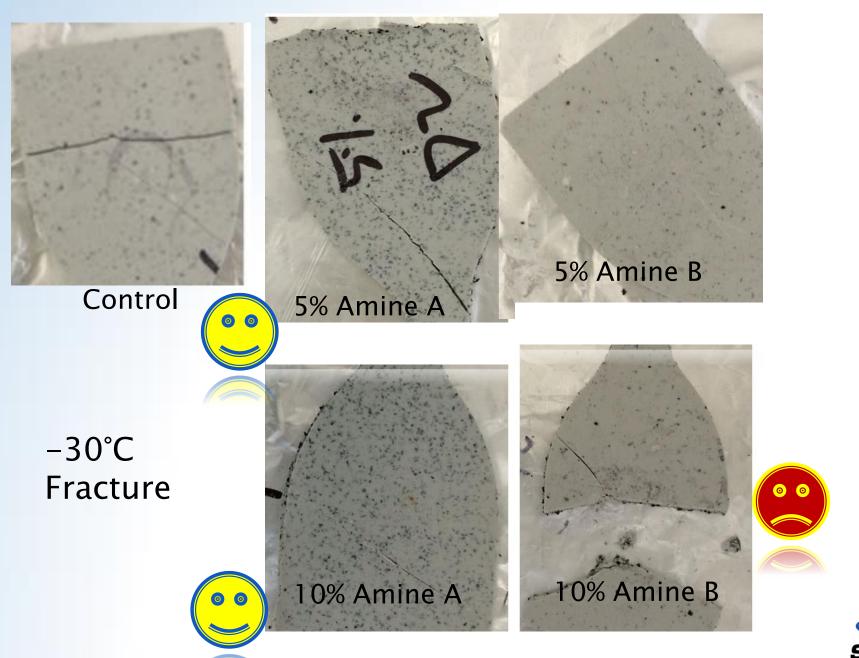


-15°C Fracture



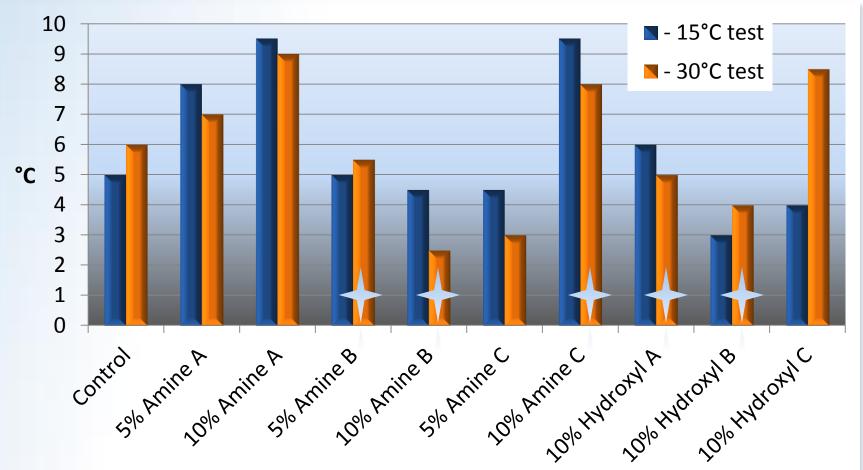




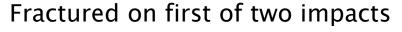




Low Temperature Impact









Conclusions

- In the Shore D systems, silicone reduces hardness.
 - Slowly up to 20%
- Strength and elongation improve and maximize at ~10-20% silicone.
- Amine more effective than epoxy

- In the Shore A system, with tetra-functional Amine A, hardness is increased.
- Impact resistance is also increased.
- OH is not as effective for this.



Thank You



